BF420, BF422

High Voltage Transistors

NPN Silicon

• Pb-Free Package is Available*

MAXIMUM RATINGS

Rating	Symbol	BF420	BF422	Unit
Collector - Emitter Voltage	V _{CEO}	300 250		Vdc
Collector - Base Voltage	V _{CBO}	300 250		Vdc
Emitter-Base Voltage	V _{EBO}	5.0		Vdc
Collector Current – Continuous	Ic	50		mAdc
Collector Current - Peak	I _{CM}	100		mA
Total Device Dissipation (Note 1) @ T _A = 25°C Derate above 25°C	P _D	830 6.6		mW mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	150	°C/W
Thermal Resistance, Junction to Lead	$R_{ heta JL}$	68	°C/W

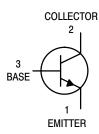
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Mounted on a FR4 board with 200 mm² of 1 oz copper and lead length of



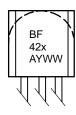
ON Semiconductor®

http://onsemi.com





TO-92 (TO-226AA) CASE 29-11, STYLE 14 MARKING DIAGRAM



c = 0 or 2

A = Assembly Location

Y = Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
BF420ZL1	TO-92	2000 Ammo Pack
BF422	TO-92	5000 Units/Box
BF422G	TO-92 (Pb-Free)	5000 Units/Box
BF422RL1	TO-92	2000 Tape & Reel
BF422ZL1	TO-92	2000 Ammo Pack

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

BF420, BF422

$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_A = 25^{\circ}C \ unless \ otherwise \ noted)$

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS		I.			
Collector – Emitter Breakdown Voltage (Note 220 $(I_C = 1.0 \text{ mAdc}, I_B = 0)$	BF420 BF422	V _{(BR)CEO}	300 250	=	Vdc
Collector – Base Breakdown Voltage ($I_C = 100 \mu Adc, I_E = 0$)	BF420 BF422	V _{(BR)CBO}	300 250	_	Vdc
Emitter – Base Breakdown Voltage ($I_E = 100 \mu Adc, I_C = 0$)	BF420 BF422	V _{(BR)EBO}	5.0 5.0	_	Vdc
Collector Cutoff Current (V _{CB} = 200 Vdc, I _E = 0)	BF420 BF422	I _{CBO}	_ _	0.01	μAdc
Emitter Cutoff Current (V _{EB} = 5.0 Vdc, I _C = 0)	BF420 BF422	I _{EBO}	_	100 —	nAdc
ON CHARACTERISTICS					
DC Current Gain (I _C = 25 mAdc, V _{CE} = 20 Vdc)	BF420 BF422	h _{FE}	50 50	_	_
Collector – Emitter Saturation Voltage ($I_C = 20 \text{ mAdc}$, $I_B = 2.0 \text{ mAdc}$)		V _{CE(sat)}	_	0.5	Vdc
Base – Emitter Saturation Voltage (I _C = 20 mAdc, I _B = 2.0 mAdc)		V _{BE(sat)}	_	2.0	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current Gain — Bandwidth Product $(I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 20 \text{ MHz})$		f _T	60	_	MHz
Common Emitter Feedback Capacitance (V _{CB} = 30 Vdc, I _E = 0, f = 1.0 MHz)		C _{re}	_	1.6	pF

^{2.} Pulse Test: Pulse Width \leq 300 μ s; Duty Cycle \leq 2.0%.

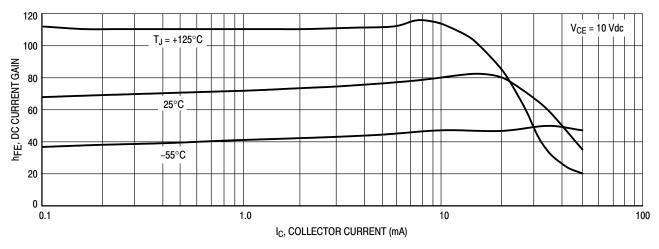


Figure 1. DC Current Gain

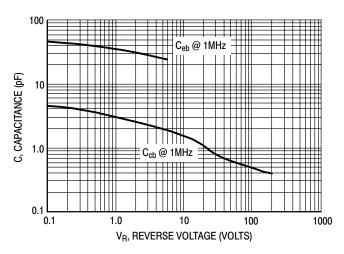


Figure 2. Capacitance

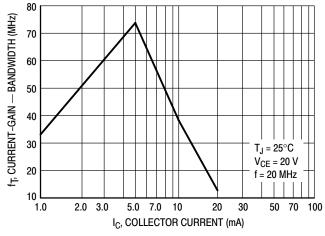


Figure 3. Current-Gain - Bandwidth

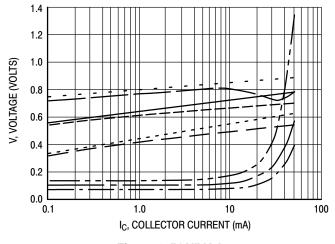
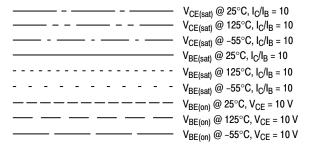
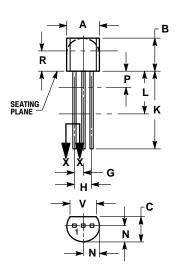


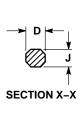
Figure 4. "ON" Voltages



PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 029-11 **ISSUE AJ**





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
Р		0.100		2.54	
R	0.115		2.93		
٧	0.135		3.43		

STYLE 14:

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